## NOTICE OF APPEAL FROM THE EXAMINER TO THE BOARD OF PATENT APPEALS AND INTERFERENCES

In re applicat	ion of:		11-31794
Confirmation	No.:	7595	
Serial No.: 0	9/992,38	87	
For: FLIP	-CHIP O	ON FILM ASSEMBLY FOR BALL GRID ARRAY PACKAGES	
Filed: 11/16	5/2001		
Examiner: I	Lewis, M	Monica	
Group Art U	nit: 2822	2	
Mail Stop Al Commissione P. O. Box 14 Alexandria,	er for Pat 50		
Sir:			
Appl	icants he	ereby appeal to the Board of Patent Appeals and Interferences from the decisio	n in the Office
Action dated	04/20/2	2006 of the Primary Examiner finally rejecting claims <u>25-31</u> .	
The i	tem (s) c	checked below are appropriate:	
1. <u>X</u>	An extension of time to respond to the final rejection		
		was granted on	
	<u>X</u>	is requested for $3$ month(s).	
2	A time	nely response to the final rejection has been filed, as provided in 841 O.G. 1411.	
3. <u>X</u>	Fee \$5	500.00:	
		Not required (Fee paid in prior appeal)	
	<u>X</u>	The Commissioner is hereby requested to grant any time extension that may authorized to charge any fees which may be required incident to this filing overpayment to Deposit Account No. 20-0668.	
Signature [R	ule 191(b	Respectfully submitted,  /Yingsheng Tung/	
		Yingsheng Tung Reg. No. 52,305	

Post Office Address (to which correspondence is to be sent) Texas Instruments Incorporated P.O. Box 655474, M.S. 3999 Dallas, TX 75265